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## IRF330-333/IRF730-733 MTM/MTP5N35/5N40 N-Channel Power MOSFETs, 5.5 A, 350 V/400 V

Power And Discrete Division

### Description

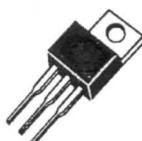
These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

- $V_{GS}$  Rated at  $\pm 20$  V
- Silicon Gate for Fast Switching Speeds
- $I_{DSS}$ ,  $V_{DS(on)}$ , SOA and  $V_{GS(th)}$  Specified at Elevated Temperature
- Rugged

TO-204AA



TO-220AB



IRF330  
IRF331  
IRF332  
IRF333  
MTM5N35  
MTM5N40

IRF730  
IRF731  
IRF732  
IRF733  
MTP5N35  
MTP5N40

### Maximum Ratings

Symbol	Characteristic	Rating IRF330/332 IRF730/732 MTM/MTP5N40	Rating IRF331/333 IRF731/733 MTM/MTP5N35	Unit
$V_{DSS}$	Drain to Source Voltage	400	350	V
$V_{DGR}$	Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$	400	350	V
$V_{GS}$	Gate to Source Voltage	$\pm 20$	$\pm 20$	V
$T_J$ , $T_{stg}$	Operating Junction and Storage Temperature	-55 to +150	-55 to +150	°C
$T_L$	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	°C

### Maximum On-State Characteristics

		IRF330/331 IRF730/731	IRF332/333 IRF732/733	MTM5N35/40 MTP5N35/40	
$R_{DS(on)}$	Static Drain-to-Source On Resistance	1.0	1.5	1.0	Ω
$I_D$	Drain Current Continuous Pulsed	5.5 22	4.5 22	5.0 22	A

### Maximum Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.67	1.67	1.67	°C/W
$P_D$	Total Power Dissipation at $T_C = 25^\circ\text{C}$	75	75	75	W

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.



## IRF330-333/IRF730-733

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**Electrical Characteristics** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
<b>Off Characteristics</b>					
$V_{(\text{BR})\text{DSS}}$	Drain Source Breakdown Voltage <sup>1</sup> IRF330/332/730/732 IRF331/333/731/733			V	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$
		400			
		350			
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current		250	$\mu\text{A}$	$V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}$
			1000	$\mu\text{A}$	$V_{DS} = 0.8 \times \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}, T_C = 125^\circ\text{C}$
$I_{\text{GSS}}$	Gate-Body Leakage Current IRF330-333 IRF730-733		$\pm 100$ $\pm 500$	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
<b>On Characteristics</b>					
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 250 \mu\text{A}, V_{DS} = V_{GS}$
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance <sup>2</sup> IRF330/331/730/731 IRF332/333/732/733			$\Omega$	$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}$
			1.0		
			1.5		
$g_{fs}$	Forward Transconductance	3.0		S ( $\Omega$ )	$V_{DS} = 10 \text{ V}, I_D = 3.0 \text{ A}$
<b>Dynamic Characteristics</b>					
$C_{iss}$	Input Capacitance		900	pF	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$ $f = 1.0 \text{ MHz}$
$C_{oss}$	Output Capacitance		300	pF	
$C_{rss}$	Reverse Transfer Capacitance		80	pF	
<b>Switching Characteristics</b> ( $T_C = 25^\circ\text{C}$ , Figures 12, 13)					
$t_{d(on)}$	Turn-On Delay Time		30	ns	$V_{DD} = 175 \text{ V}, I_D = 3.0 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{GEN} = 15 \Omega$ $R_{GS} = 15 \Omega$
$t_r$	Rise Time		35	ns	
$t_{d(off)}$	Turn-Off Delay Time		55	ns	
$t_f$	Fall Time		35	ns	
$Q_g$	Total Gate Charge		30	nC	
					$V_{GS} = 10 \text{ V}, I_D = 7.0 \text{ A}$ $V_{DD} = 180 \text{ V}$
<b>Symbol</b> <b>Characteristic</b> <b>Typ</b> <b>Max</b> <b>Unit</b> <b>Test Conditions</b>					
<b>Source-Drain Diode Characteristics</b>					
$V_{SD}$	Diode Forward Voltage IRF330/331/730/731 IRF332/333/732/733		1.6	V	$I_S = 5.5 \text{ A}; V_{GS} = 0 \text{ V}$
			1.5	V	$I_S = 4.5 \text{ A}; V_{GS} = 0 \text{ V}$
$t_{rr}$	Reverse Recovery Time	400		ns	$I_S = 5.5 \text{ A}; dI_S/dt = 100 \text{ A}/\mu\text{s}$

## MTM/MTP5N35/5N40

**Electrical Characteristics ( $T_C = 25^\circ\text{C}$  unless otherwise noted)**

Symbol	Characteristic	Min	Max	Unit	Test Conditions
<b>Off Characteristics</b>					
$V_{(\text{BR})\text{DSS}}$	Drain Source Breakdown Voltage <sup>1</sup>			V	$V_{GS} = 0 \text{ V}, I_D = 5.0 \text{ mA}$
	MTM/MTP5N40	400			
	MTM/MTP5N35	350			
$I_{DSS}$	Zero Gate Voltage Drain Current		0.25	mA	$V_{DS} = 0.85 \times \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}$
			2.5	mA	$V_{DS} = 0.85 \times \text{Rated } V_{DSS}, V_{GS} = 0 \text{ V}, T_C = 100^\circ\text{C}$
$I_{GSS}$	Gate-Body Leakage Current		$\pm 500$	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
<b>On Characteristics</b>					
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0	4.5	V	$I_D = 1.0 \text{ mA}, V_{DS} = V_{GS}$
		1.5	4.0	V	$I_D = 1.0 \text{ mA}, V_{DS} = V_{GS}, T_C = 100^\circ\text{C}$
$R_{DS(\text{on})}$	Static Drain-Source On-Resistance <sup>2</sup>		1.0	$\Omega$	$V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$
$V_{DS(\text{on})}$	Drain-Source On-Voltage <sup>2</sup>		2.5	V	$V_{GS} = 10 \text{ V}; I_D = 2.5 \text{ A}$
			6.2	V	$V_{GS} = 10 \text{ V}, I_D = 5.0 \text{ A}$
			5.0	V	$V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}, T_C = 100^\circ\text{C}$
$g_{fs}$	Forward Transconductance	2.0		S ( $\mu$ )	$V_{DS} = 10 \text{ V}, I_D = 2.5 \text{ A}$
<b>Dynamic Characteristics</b>					
$C_{iss}$	Input Capacitance		1200	pF	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$ $f = 1.0 \text{ MHz}$
$C_{oss}$	Output Capacitance		300	pF	
$C_{rss}$	Reverse Transfer Capacitance		80	pF	
<b>Switching Characteristics (<math>T_C = 25^\circ\text{C}</math>, Figures 12, 13)<sup>3</sup></b>					
$t_{d(on)}$	Turn-On Delay Time		50	ns	$V_{DD} = 25 \text{ V}, I_D = 2.5 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{\text{GEN}} = 50 \Omega$ $R_{GS} = 50 \Omega$
$t_r$	Rise Time		100	ns	
$t_{d(off)}$	Turn-Off Delay Time		200	ns	
$t_f$	Fall Time		100	ns	
$Q_g$	Total Gate Charge		30	nC	$V_{GS} = 10 \text{ V}, I_D = 7.0 \text{ A}$ $V_{DD} = 180 \text{ V}$

**Notes**

1.  $T_J = +25^\circ\text{C}$  to  $+150^\circ\text{C}$

2. Pulse test: Pulse width  $\leq 80 \mu\text{s}$ , Duty cycle  $\leq 1\%$

3. Switching time measurements performed on LEM TR-58 test equipment.